# **DISPLAYTRONIC**

XIAMEN ZETTLER ELECTRONICS CO., LTD

# SPECIFICATIONS FOR LIQUID CRYSTAL DISPLAY

	<b>CUSTOMER APP</b>	PROVAL	
<b>X PART NO.</b>	AGM1212I-NLW-BBH-	-WB(DISPLAYT	TRONIC) VER1.0
APPROVAL		COMPANY	,
122 2 2 2 3 7 1 2 2		СНОР	
CUSTOMER			
COMMENTS			

DISPLAYTI	DISPLAYTRONIC ENGINEERING APPROVAL										
DESIGN BY	DESIGN BY CHECKED BY APPROVED BY										

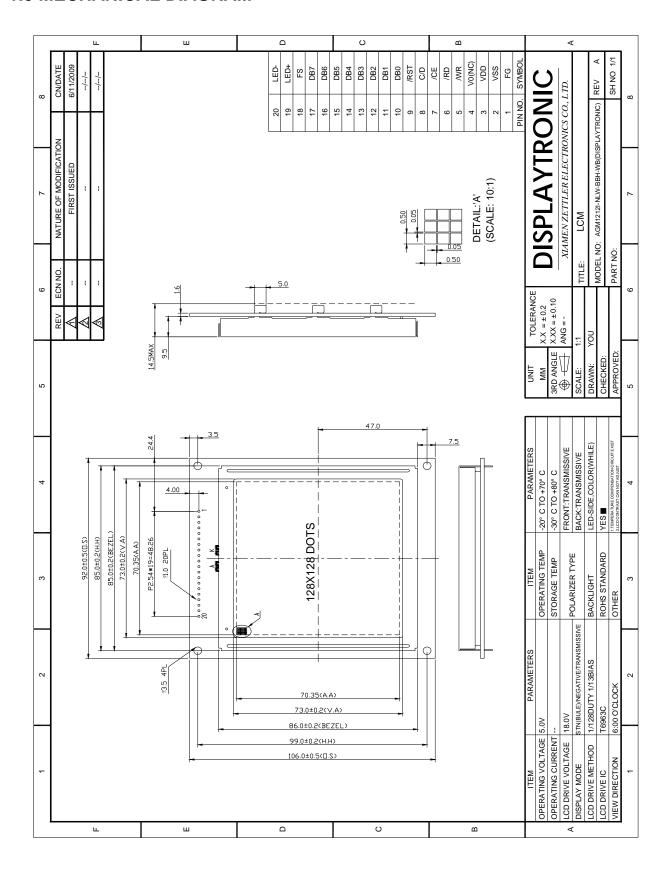
# **REVISION RECORD**

REVISION	REVISION DATE	PAGE	CONTENTS
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#### 1.0 MECHANICAL DIAGRAM



#### 2.0 MECHANICAL SPECS

1. Display Format	128*64 DOTS
2. Power Supply	5.0V
3. Overall Module Size	92.0mm(W) x 106.0mm(H) x max14.5mm(D)
4. Viewing Aera(W*H)	73.0mm(W) x 73.0mm(H)
5. Dot Size (W*H)	0.50mm(W) x 0.50mm(H)
6. Dot Pitch (W*H)	0.55mm(W) x 0.55mm(H)
7. Viewing Direction	6:00 O'Clock
8. Driving Method	1/128 Duty,1/13 Bias
9. Controller IC	T6963C
10. LC Fluid Options	STN(BULE) /NEGATIVE
11. Polarizer Options	Transmissive
12. Backlight Options	LED-side(while)
13. Operating temperature	-20°C ~ 70°C
14. Storage temperature	-30°C ~ 80°C

## 3.0 ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Min	Тур	Max	Unit
Operating temperature	Тор	-20	-	70	°C
Storage temperature	Tst	-30	-	80	°C
Input voltage	Vin	-0.3	-	Vdd+0.3	V
Supply voltage for logic	Vdd- Vss	-0.3	-	7.0	V
Supply voltage for LCD drive	Vdd- V0	6		28	V

# 4.0 ELECTRICAL CHARACTERISTICS

#### 4.1 Electrical Characteristics Of LCM

ltem	Symbol	Condition	Min	Тур	Max	Unit		
Power Supply Voltage	VDD	Ta=25°C	4.8	5.0	5.2	V		
Power Supply Current	ldd	Vdd=5.0V			40.0	mA		
Input voltage (high)	Vih	H level	Vdd-2.2		Vdd	V		
Input voltage (low)	Vil	L level	0		0.8	V		
		-20°C	18.1	18.3	18.5			
Recommended LC Driving	Vdd -Vo	25°C	17.8	18.0	18.2-	V		
Voltage		70°C	17.4	17.6	17.8	1		

#### 4.2 The Characteristics Of Backlight

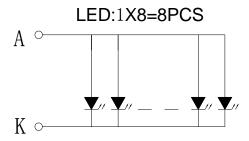
#### 4.2.1 Electrical-Optical Characteristics Of LED Backlight (Ta=25°C)

Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Current	If	V=5.0V,R=16.5 Ω		120	150	mA
Reverse Voltage	Vr				5	V
Luminance	Lv	If=120mA	280	300		cd/m²
Uniformity	Δ	(Lvmin/Lvmax)%	75%			
Spectral line half width	Δλ	If=120mA				um
Chroma coordinate	х	If=120mA	0.26		0.28	um
Officina coordinate	у	If=120mA	0.26		0.28	um
Lifetime		If=120mA			20000	Hours

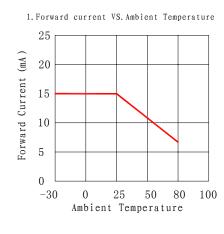
#### NOTE:

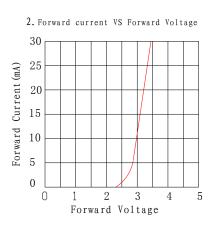
- (1)The luminance is the average value of 5 points, The measurement instrument is BM-7 luminance colorimeter. The diameter of aperture is  $\Phi$ 5mm
  - (2) Luminance means the backlight brightness without glass.
- (3) Backlight lifetime means luminance value larger than half the original after 20000 hours' continuous work.

#### 4.2.2 Circuit Diagram of Backlight (1x8=8 pcs LED)



#### 4.2.3 LED Characteristics Curves (for single led)

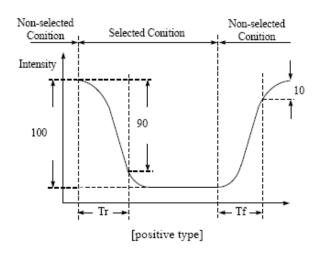


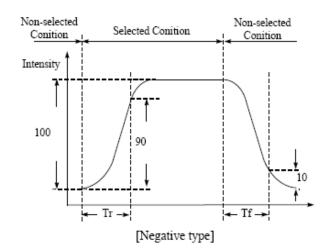


#### 5.0 OPTICAL CHARACTERISTICS

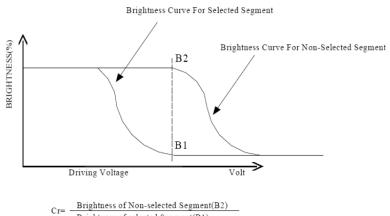
Item	Symbol	Condition	Min	Тур	Max	Unit
Viewing angle (horizontal)	θ	Cr ≥ 2.0	-35	-	35	deg
Viewing angle (vertical)	ф	Cr ≥ 2.0	-25	-	45	deg
Contrast Ratio	Cr	φ=0°, θ=0°	5.0		-	
Response time (rise)	Tr	φ=0°, θ=0°	-	150	250	ms
Response time (fall)	Tf	φ=0°, θ=0°	-	160	280	ms
Luminance	Lv	Covered by LCD and Touch panel	23			cd/m <sup>2</sup>

# (1). Definition of Optical Response Time



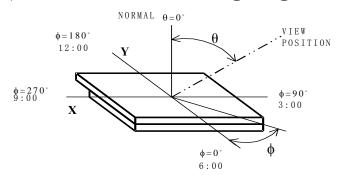


# (2). Definition of Contrast Ratio

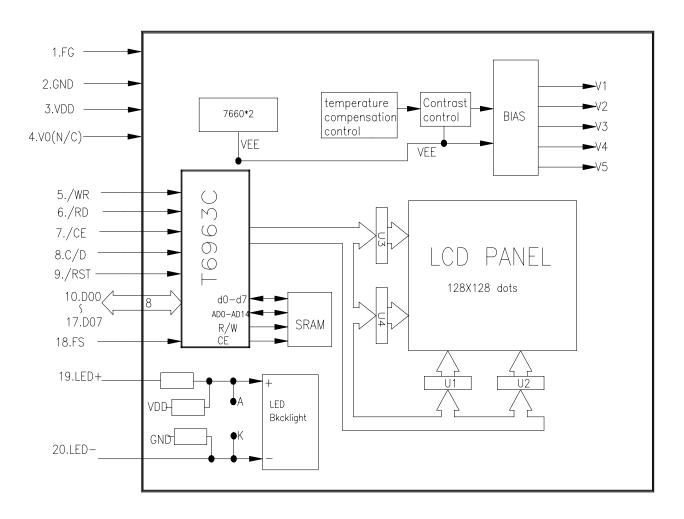


Brightness of selected Segment(B1)

# (3). Definition of Viewing Angle $\theta$ and $\Phi$



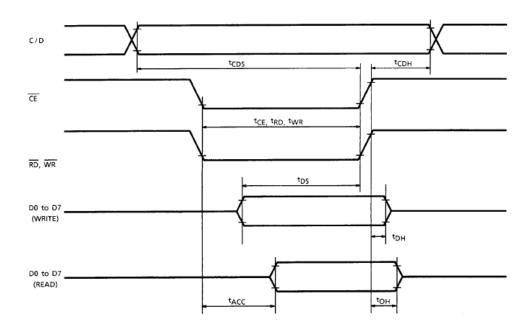
#### 6.0 BLOCK DIAGRAM



# 7.0 PIN ASSIGNMENT

Pin No.	Symbol	atio	Level
1	FG	Frame Ground	-
2	vss	Ground	-
3	Vdd	+5V	-
4	NC	NC	-
5	/WR	Write Data	H/L
6	/RD	Read Data	H/L
7	/CE	Chip Enable	H, H→L
8	C/D	Command/Data	H/L
9	/RST	Reset	L
10	DB0	Data bit 0	H/L
11	DB1	Data bit 1	H/L
12	DB2	Data bit 2	H/L
13	DB3	Data bit 3	H/L
14	DB4	Data bit 4	H/L
15	DB5	Data bit 5	H/L
16	DB6	Data bit 6	H/L
17	DB7	Data bit 7	H/L
18	FS	Font select	H/L
19	LED+	Power Supply for LED+	
20	LED-	Power Supply for LED-	-

# **8.0 TIMING CHARACTERISTICS**



TEST CONDITIONS (Unless otherwise noted,  $V_{DD}$  = 5.0V  $\pm$  10%,  $V_{SS}$  = 0V, Ta = - 20 to 75°C)

ITEM	SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
C/D Set-up Time	tCDS	_	100	_	ns
C/D Hold Time	t <sub>CDH</sub>	_	10	_	ns
CE, RD, WR Pulse Width	tCE, tRD, tWR	_	80	_	ns
Data Set-up Time	t <sub>DS</sub>	<del>-</del>	80	_	ns
Data Hold Time	t <sub>DH</sub>		40	_	ns
Access Time	tACC	-	_	150	ns
Output Hold Time	tОН	_	10	50	ns

## 9.0 RELIABILITY TEST

NO	Test Item		Description	<b>Test Condition</b>	Remark
1		High temperature storage	Applying the high storage temperature Under normal humidity for a long time Check normal performance	80 <b>°</b> C 96hrs	
2		Low temperature storage	Applying the low storage temperature Under normal humidity for a long time Check normal performance	-30 <b>°</b> C 96hrs	
3		High temperature Operation	Apply the electric stress(Volatge and current) Under high temperature for a long time	70 °C 96hrs	Note1
4	Environmenta	Low temperature Operation	Apply the electric stress Under low temperature for a long time	-20 <b>°</b> C 96hrs	Note1 Note2
5	Test	High temperature/High Humidity Storage	Apply high temperature and high humidity storage for a long time	90% RH 40 <b>º</b> C 96hrs	Note2
6		Temperature Cycle	-30 <b>º</b> C/80 <b>º</b> C 10 cycle		
7	Vibration test(Package state)  Mechanical Test		Applying vibration to product check normal performance	Freq:10-55Hz Max Acceleration 5G 1cycle time:1min time X.Y.Z direction for 15 mines	
8		Shock test(package state)	Applying shock to product check normal performance	Drop them through 70cm height to strike horizontal plane	
9	Other			•	

#### Remark

Note1:Normal operations condition (25°C±5°C).

Note2:Pay attention to keep dewdrops from the module during this test.

## **10.0 DISPLAY CONTROL INSTRUCTION**

The display control instructions control the internal state of the T6963c.

COMMAND	Cor	ntrol S	tate		Code					DESCRIPTION		
COMMAND	CD	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	
REGISTERS SETTIBG	1	1	0	0	0	1	0	0	N2	N1	N0	N2 N1 N0 0 0 1 Set Cursor Pointer 0 1 0 Set Offset Register 1 0 0 Set address Pointer
SET CONTROL WORD	1	1	0	0	1	0	0	0	0	N1	N0	N1 N0 0 0 Set Text Home Address 1 1 Set Text Area 2 0 Set Graphic Home Address 1 1 Set Graphic Area
MODE SET	1	1	0	1	0	0	0	CG	N2	N1	N0	CG=0: Internal CG ROM Mode CG=1: Internal CG ROM Mode N2 N1 N0 Graphic & Text 0 0 0 OR Mode 0 0 1 Exor Mode 0 1 1 And Mode 1 0 0 Text Attribute Mode
DISPLAY MODE	1	1	0	1	0	0	1	N3	N2	N1	N0	N3=0: Display Off N3=1: Display On N2=0:Text Off N2=1: Text On N1=0: Cursor Off N1=1: Cursor On N0=0: Blink Off N0=1: Blink On
CURSOR PATTERN SELECT	1	1	0	1	0	1	0	0	N2	N1	N0	N2,N1,N0 Line Number of Cursor N2 N1 N0 0 0 0 1-Line Cursor (Bottom Line) 1 1 8-Line Cursor (8x8Dots)
DATA AUTO READ/WRITE	1	1	0	1	0	1	1	0	0	N1	N0	N1 N0 0 0 Data Auto Write 0 1 Data Auto Read 1 * Auto Reset
DATA READ/WRITE	1	1	0	1	1	0	0	0	N2	N1	N0	N2=0: ADP Variable N2=1: ADP Nonvariable N1=0: Increment ADP N1 =1: Decrement ADP N0=0: Data Write N0=1: Data Read
SCREEN PEEK	1	1	0	1	1	1	0	0	0	0	0	Screan Peek
SCREEN COPY	1	1	0	1	1	1	0	1	0	0	0	Screen Copy
BIT SET/RESET	1	1	0	1	1	1	1	N3	N2	N1	N0	N3=0: Bit Reset N3=1: Bit Set N2, N1, N0 Bit Address 000-D0, 111-D7
DATA WRITE	0	1	0		Write Data							Writes data DB0~DB7 into display data RAM. After writing instruction
DATA READ	0	0	1			Ī	Read	Data	a			Reads data DB0~DB7 from display data RAM to the data bus.

#### 11.0 PRECAUTION FOR USING LCM

- 1. When design the product with this LCD Module, make sure the viewing angle matches to its purpose of usage.
- 2. As LCD panel is made of glass substrate, Dropping the LCD module or banging it against hard objects may cause cracking or fragmentation. Especially at corners and edges.
- 3. Although the polarizer of this LCD Module has the anti-glare coating, always be careful not to scratch its surface. Use of a plastic cover is recommended to protect the surface of polarizer.
- 4. If the LCD module is stored at below specified temperature, the LC material may freeze and be deteriorated. If it is stored at above specified temperature, the molecular orientation of the LC material may change to Liquid state and it may not revert to its original state. Excessive temperature and humidity could cause polarizer peel off or bubble. Therefore, the LCD module should always be stored within specified temperature range.
- 5. Saliva or water droplets must be wiped off immediately as those may leave stains or cause color changes if remained for a long time. Water vapor will cause corrosion of ITO electrodes.
- 6. If the surface of LCD panel needs to be cleaned, wipe it swiftly with cotton or other soft cloth. If it is not still clean enough, blow a breath on the surface and wipe again.
- 7. The module should be driven according to the specified ratings to avoid malfunction and permanent damage. Applying DC voltage cause a rapid deterioration of LC material. Make sure to apply alternating waveform by continuous application of the M signal. Especially the power ON/OFF sequence should be kept to avoid latch-up of driver LSIs and DC charge up to LCD panel.
- 8. Mechanical Considerations
  - a) LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.
  - b) Do not tamper in any way with the tabs on the metal frame.
  - Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattern.
  - Do not touch the elastomer connector; especially insert a backlight panel (for example, EL).
  - When mounting a LCM makes sure that the PCB is not under any stress such as bending or twisting.
     Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
  - f) Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels.
- 9. Static Electricity
  - a) Operator

Ware the electrostatics shielded clothes because human body may be statically charged if not ware shielded clothes. Never touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.

b) Equipment

There is a possibility that the static electricity is charged to the equipment, which has a function of peeling or friction action (ex: conveyer, soldering iron, working table). Earth the equipment through proper resistance (electrostatic earth: 1x10<sup>8</sup> ohm).

Only properly grounded soldering irons should be used.

If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.

The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.

c) Floor

Floor is the important part to drain static electricity, which is generated by operators or equipment.

There is a possibility that charged static electricity is not properly drained in case of insulating floor. Set the electrostatic earth (electrostatic earth: 1x10<sup>8</sup> ohm).

d) Humidity

Proper humidity helps in reducing the chance of generating electrostatic charges. Humidity should be kept over 50%RH.

e) Transportation/storage

The storage materials also need to be anti-static treated because there is a possibility that the human body or storage materials such as containers may be statically charged by friction or peeling.

The modules should be kept in antistatic bags or other containers resistant to static for storage.

f) Soldering

Solder only to the I/O terminals. Use only soldering irons with proper grounding and no leakage.

Soldering temperature : 280 $^{\circ}$  C  $\pm$  10 $^{\circ}$  C

Soldering time: 3 to 4 sec.

Use eutectic solder with resin flux fill.

If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed afterwards.

g) Others

The laminator (protective film) is attached on the surface of LCD panel to prevent it from scratches or stains. It should be peeled off slowly using static eliminator.

Static eliminator should also be installed to the workbench to prevent LCD module from static charge.

- 10. Operation
  - a) Driving voltage should be kept within specified range; excess voltage shortens display life.
  - b) Response time increases with decrease in temperature.
  - c) Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".
  - d) Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear "fractured".
- 11. If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. The toxicity is extremely low but caution should be exercised at all the time.
- 12. Disassembling the LCD module can cause permanent damage and it should be strictly avoided.
- 13. LCD retains the display pattern when it is applied for long time (Image retention). To prevent image retention, do not apply the fixed pattern for a long time. Image retention is not a deterioration of LCD. It will be removed after display pattern is changed.
- 14. Do not use any materials, which emit gas from epoxy resin (hardener for amine) and silicone adhesive agent (dealcohol or deoxym) to prevent discoloration of polarizer due to gas.
- 15. Avoid the exposure of the module to the direct sunlight or strong ultraviolet light for a long time. The brightness of LCD module may be affected by the routing of CCFL cables due to leakage to the chassis through coupling effect. The inverter circuit needs to be designed taking the level of leakage current into consideration. Thorough evaluation is needed for LCD module and inverter built into its host equipment to ensure specified brightness.